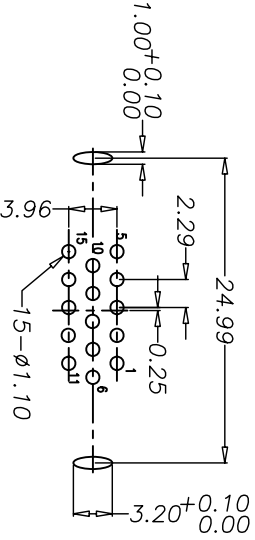
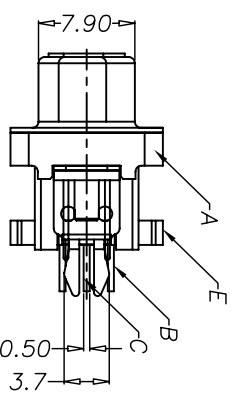
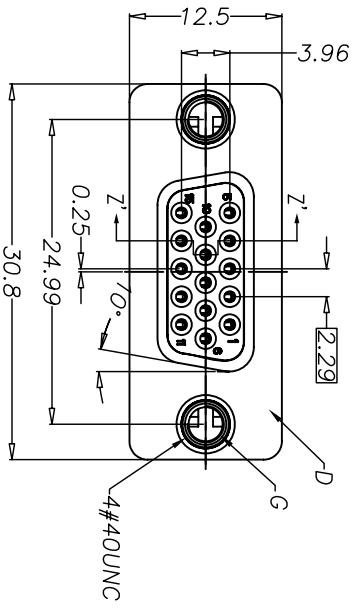
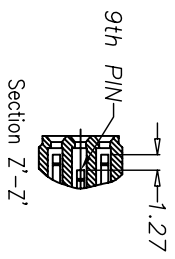


H: DATE CODE:
 YY:YEAR(08~)
 MM:MONTH(01~12)
 DD:DAY(01~31)



RECOMMEND PCB LAYOUT(TOP VIEW)
 PCB THICKNESS:1.60±0.10mm.
 TOLERANCE:±0.05mm.



- SPECIFICATIONS:
- OTHER GENERAL SPEC. TO REFER "D-SUB(9 PIN) High Density PRODUCT SERIES SPEC";
 - TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
 - PACKAGE : SEE "2DS1544-001221" PACKAGE.
 - GREEN PRODUCT IDENTIFICATION LABEL ON PACKAGING: **G.P PASS**
 - FOR WAVE SOLDERING LEAD-FREE PROCESS.

- 2DS1544-00X2X1
- PACKAGE
 - 1: TRAY
 - HOUSING COLOR
 - 1: BLACK
 - 2: BLUE
 - CONTACT PLATING
 - 2: Au G.F PLATING ; Matt Tin
 - COVER COLOR
 - 0: BLACK
 - 1: BLUE
 - SCREW
 - 0: 無螺絲

REV/ECN NO	OR DESCRIPTION	REVISED	DATE
A	PDR Release	Amyc	2009/09/21
B	PDR Release	IRENE	2009/10/06

H	INK	1	Dominio IR-270BK & MC-270BK	BLACK
G	RIVET	2	COPPER ALLOY	NICKEL PLATING
F	BOARD LOCK	2	SPPC T=0.40mm	Tin PLATING
E	COVER	1	PBT+30%GF UL94V-0	SEE "PART NO"
D	SHELL	1	SPPC T=0.40mm	NICKEL PLATING
C	SHORT9 CONTACT	5	PHOSPHOR BRONZE T=0.2mm	Contact area: Gold Flash Plating Solder area: Matt Tin Plating
B	CONTACT	10	PHOSPHOR BRONZE T=0.2mm	Contact area: Gold Flash Plating Solder area: Matt Tin Plating
A	HOUSING	1	PBT+30%GF UL94V-0	SEE "PART NO"
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES: X :±0.5 X :±2° X X :±0.3 X X :±1' X X X :±0.2

Singatron Enterprise Co., Ltd.
 信音企業股份有限公司

TITLE D-SUB 15P 10 HIGH LOW COST SHORT 9 ASSEMBLY
 DWG REF: 2009.01.06 PART NO. 2DS1544-00X2X1
 CHKD LAMSON 2009.01.06 SCALE: N/A UNIT: mm
 APVD LAMSON 2009.01.06 SIZE: A3 SHEET: 1 OF 1 REV: B

CUSTOMER COPY